# UNISONIC TECHNOLOGIES CO., LTD

2N65-HC **Power MOSFET** 

# 2A, 650V N-CHANNEL **POWER MOSFET**

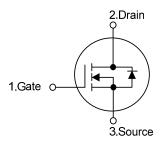
#### DESCRIPTION

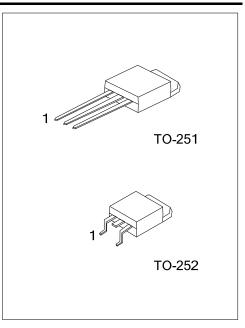
The UTC 2N65-HC is a high voltage power MOSFET designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and high rugged avalanche characteristics. This power MOSFET is usually used in high speed switching applications of switching power supplies and adaptors.

#### **FEATURES**

- \*  $R_{DS(ON)} \le 4.5\Omega$  @  $V_{GS}$ =10V,  $I_D$ =1.0A
- \* Fast switching capability
- \* Avalanche energy tested
- \* Improved dv/dt capability, high ruggedness

#### **SYMBOL**

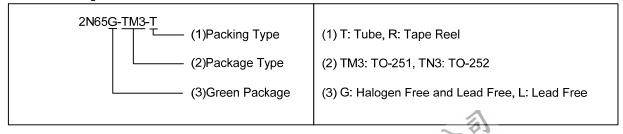




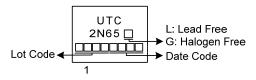
#### **ORDERING INFORMATION**

Ordering Number		Doolsone	Pin Assignment			Daakina	
Lead Free	Halogen Free	Package	1	2	3	Packing	
2N65L-TM3-T	2N65G-TM3-T	TO-251	G	D	S	Tube	
2N65L-TN3-R	2N65G-TN3-R	TO-252	G	D	S	Tape Reel	

Note: Pin Assignment: G: Gate D: Drain S: Source



#### **MARKING**



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#### **ABSOLUTE MAXIMUM RATINGS** (T<sub>C</sub> = 25°C, unless otherwise specified)

PARAMETER	SYMBOL	RATINGS	UNIT
Drain-Source Voltage	$V_{DSS}$	650	V
Gate-Source Voltage	$V_{GSS}$	±30	V
Continuous Drain Current	$I_D$	2	Α
Pulsed Drain Current (Note 2)	I <sub>DM</sub>	4	Α
Avalanche Energy Single Pulsed (Note 3)	E <sub>AS</sub>	80	mJ
Peak Diode Recovery dv/dt (Note 4)	dv/dt	0.86	V/ns
Power Dissipation	P <sub>D</sub>	56	W
Junction Temperature	TJ	+150	°C
Storage Temperature	T <sub>STG</sub>	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L = 10mH,  $I_{AS}$  = 4.0A,  $V_{DD}$  = 50V,  $R_G$  = 25  $\Omega$ , Starting  $T_J$  = 25°C
- 4.  $I_{SD} \le 3.0 A$ , di/dt  $\le 200 A/\mu s$ ,  $V_{DD} \le BV_{DSS}$ , Starting  $T_J = 25 ^{\circ}C$

#### **THERMAL DATA**

PARAMETER	SYMBOL	RATING	UNIT	
Junction to Ambient	$\theta_{JA}$	62.5	°C/W	
Junction to Case	θ <sub>JC</sub>	2.2	°C/W	

#### **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> =25°C, unless otherwise specified)

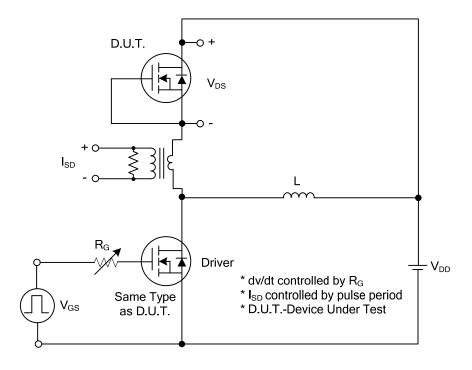
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage		$BV_{DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	650			V	
Drain-Source Leakage Current		$I_{DSS}$	$V_{DS} = 650V, V_{GS} = 0V$			10	μΑ	
Gate- Source Leakage Current	orward	I <sub>GSS</sub>	$V_{GS} = 30V, V_{DS} = 0V$			100	nA	
R	Reverse		$V_{GS} = -30V, V_{DS} = 0V$			-100	nA	
ON CHARACTERISTICS								
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.0		4.0	V	
Static Drain-Source On-State Resistance		R <sub>DS(ON)</sub>	$V_{GS} = 10V, I_D = 1.0A$			4.5	Ω	
DYNAMIC CHARACTERISTICS								
Input Capacitance		$C_{ISS}$			277		pF	
Output Capacitance		Coss	V <sub>DS</sub> =25V, V <sub>GS</sub> =0V, f=1.0MHz		51		pF	
Reverse Transfer Capacitance		$C_{RSS}$			12		pF	
SWITCHING CHARACTERISTICS								
Total Gate Charge (Note 1)		$Q_G$	V <sub>DS</sub> =100V, V <sub>GS</sub> =10V, I <sub>D</sub> =2A		14		nC	
Gate-Source Charge		$Q_GS$	I <sub>G</sub> =1mA (Note 1, 2)		3.2		nC	
Gate-Drain Charge		$Q_GD$	IG-IIIA (Note 1, 2)		2.8		nC	
Turn-On Delay Time (Note 1)		$t_{D(ON)}$			3.3		ns	
Turn-On Rise Time		$t_R$	$V_{DS}$ =100V, $V_{GS}$ =10V, $I_{D}$ =2A, $R_{G}$ =25 $\Omega$ (Note 1, 2)		16		ns	
Turn-Off Delay Time		t <sub>D(OFF)</sub>			56		ns	
Turn-Off Fall Time		$t_{\scriptscriptstyleF}$			30		ns	
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS								
Maximum Body-Diode Continuous Current		Is	10, V 0	W		2	Α	
Maximum Body-Diode Pulsed Current		I <sub>SM</sub>	X PV a CO			4	Α	
Drain-Source Diode Forward Voltage (Note 1)		$V_{SD}$	$I_S=2.0A$ , $V_{GS}=0V$			1.4	V	
Reverse Recovery Time (Note 1)		t <sub>rr</sub>	$I_S$ =2.0A , $V_{GS}$ =0V		218		ns	
Reverse Recovery Charge		Qm	di/dt=100A/µs		1.2		μC	

Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%.

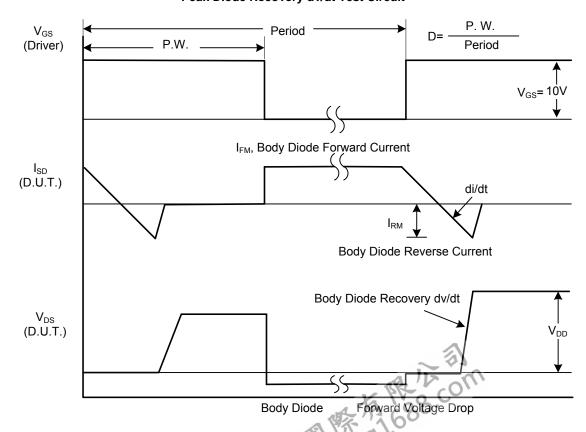
2. Essentially independent of operating temperature.

2N65-HC Power MOSFET

#### **■ TEST CIRCUITS AND WAVEFORMS**



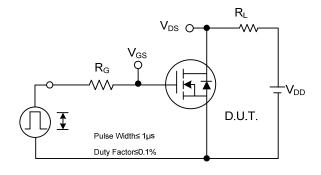
### Peak Diode Recovery dv/dt Test Circuit

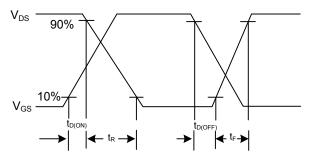


Peak Diode Recovery dv/dt Waveforms

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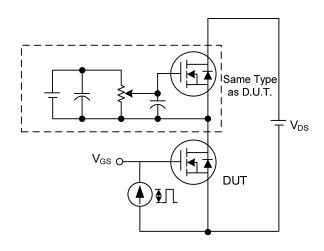
#### **TEST CIRCUITS AND WAVEFORMS**

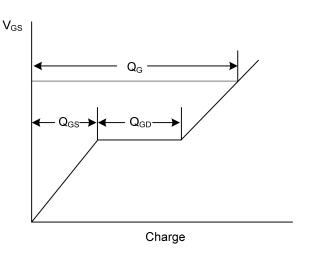




**Switching Test Circuit** 

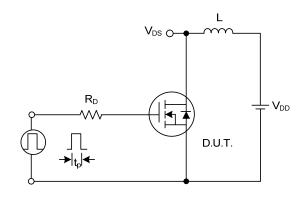
**Switching Waveforms** 

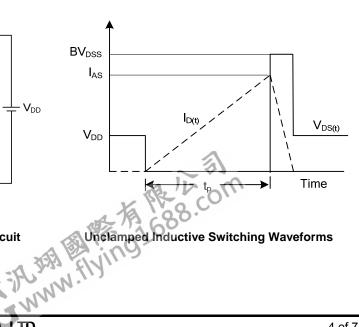




**Gate Charge Test Circuit** 

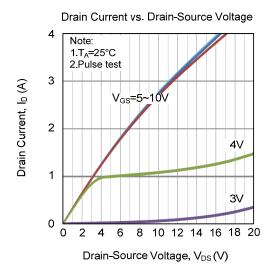
**Gate Charge Waveform** 

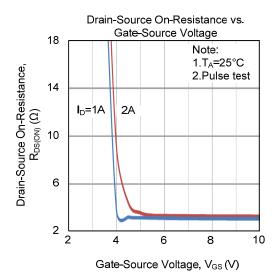


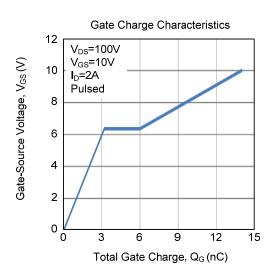


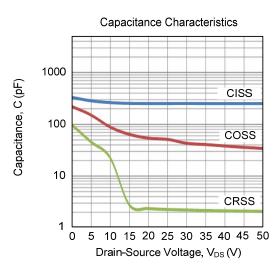
**Unclamped Inductive Switching Test Circuit** 

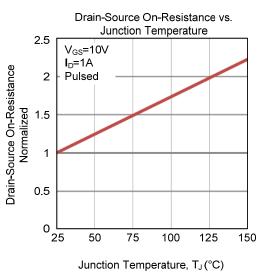
#### **■ TYPICAL CHARACTERISTICS**

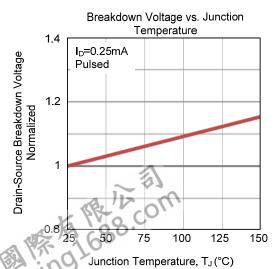




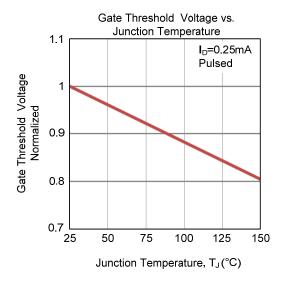


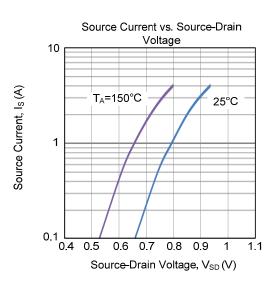


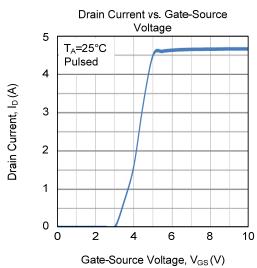


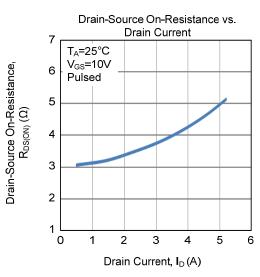


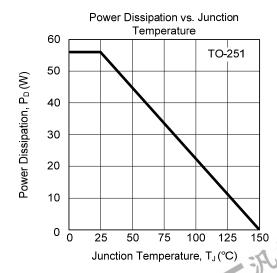
# **■ TYPICAL CHARACTERISTICS (Cont.)**

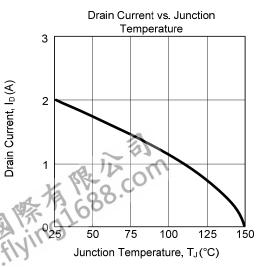




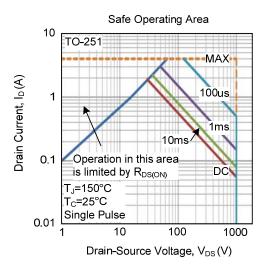








# **■ TYPICAL CHARACTERISTICS (Cont.)**



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